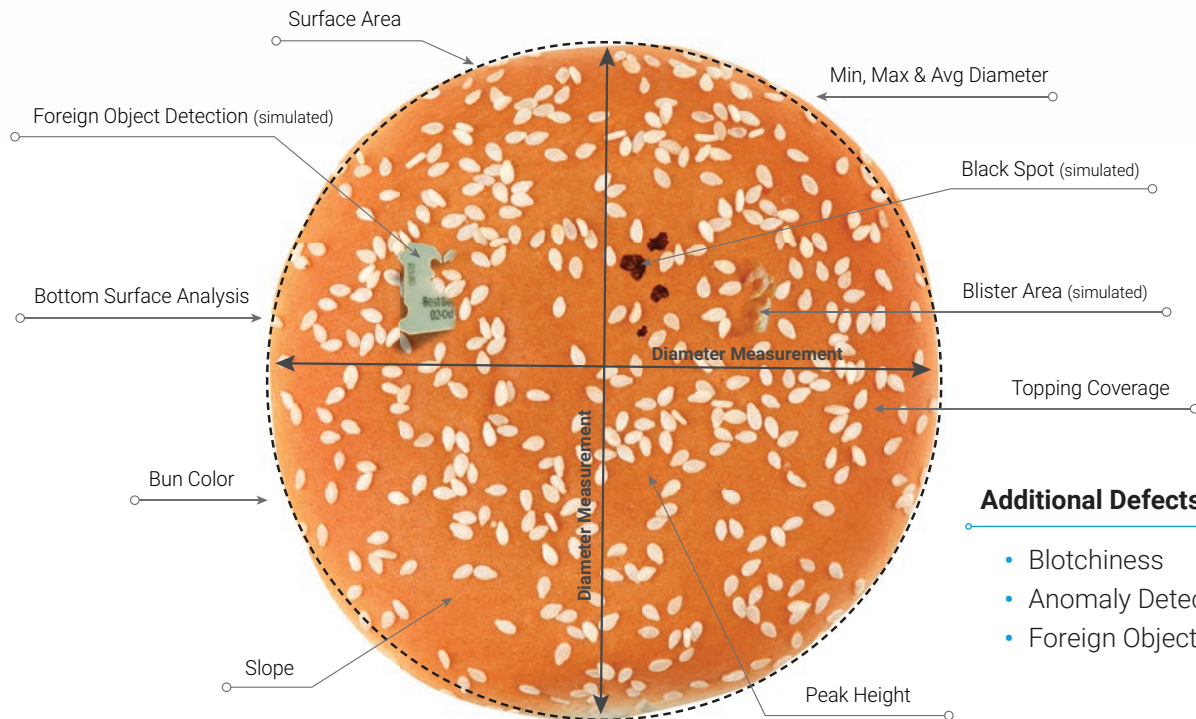




# Round Buns

## APPLICATION BRIEF

The manufacture of baked goods provides many challenges since there are a multitude of input variables that can affect product quality. The ability to continuously monitor key product attributes using real-time inspection software (e.g. bake color, peak height, slopes, blister area, etc.) in a quantifiable way, based on user-defined specification limits, provides the opportunity to respond to changes faster and more effectively.

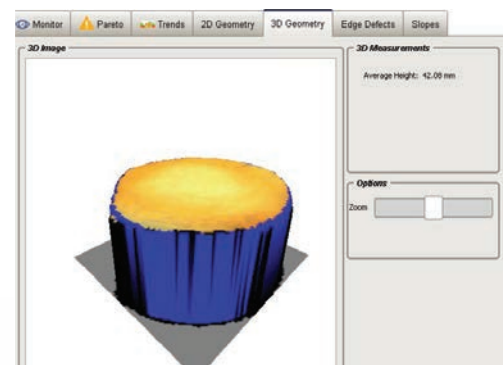


### Additional Defects Detected

- Blotchiness
- Anomaly Detection
- Foreign Objects

## HEIGHT 3D ANALYSIS

<b>Peak Height</b>	The highest point on the object when resting on a flat surface; calculated by taking the average of the 'N' highest height points measured on the top surface (N is user-configurable).
<b>Slope</b>	The curvature of the top surface on the product; measured by calculating the vertical change between the center and a user-defined ring near the edge of the product.
<b>Volume</b>	For buns baked in clusters, measure the same data as an individual bun plus the diameters of each bun, overall geometry, and confirm counts.



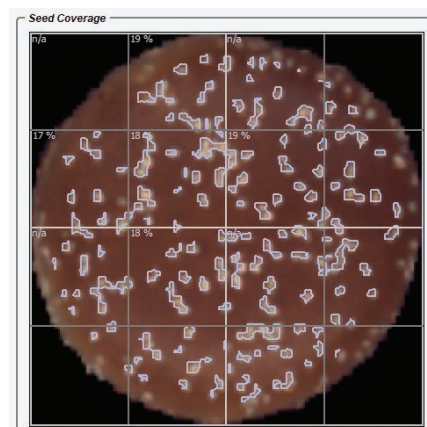
Actual 3D height values as extracted from system cameras

Virtually any food product can be measured using KPM Vision Inspection imaging technology, either directly during the production process (Over-Line/In-Line) or using a Benchtop Inspection System (Off-Line).

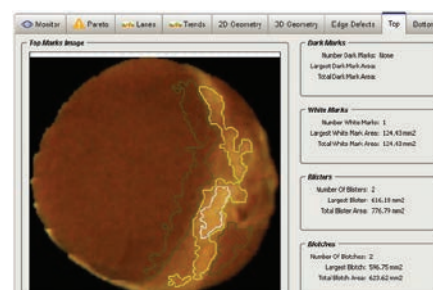
Below are some of the measurements available, particularly related to baked round buns.

## OVERHEAD 2D ANALYSIS

<b>Surface Area</b>	The overall area of the object. Used to find doubles and small products.
<b>Blister Area</b>	The area of any dark spots (i.e. blisters) on the top surface.
<b>Botchy Area</b>	The area of any white/blotchy regions (i.e. blotchiness) on the top surface.
<b>Product Color</b>	The average color of the product with all topping (if applicable) ignored for the calculation.
<b>Min/Max Diameter</b>	The minimum and maximum diameters of the object as measured through the center of the object.
<b>Topping Coverage Percentage</b>	For topped product, the percentage of the top surface covered by topping (light, dark, or both).
<b>Average Diameter</b>	The average of 180 diameters of the object as measured every one degree through the center of the object.
<b>Center Length</b>	The length of the object as measured down the center of the long axis.
<b>Center Width</b>	The width of the object as measured down the center of the short axis, perpendicular to the length measurement.
<b>Splits Data</b>	The minimum and maximum width of the split. The area % of the surface area of the product covered by the split.



Topping Coverage Analysis



Example of color anomaly detection and data reported as White Marks, Blisters, and Blotches (blobs)



Splits Analysis

## BOTTOM SURFACE ANALYSIS

<b>Bottom Color</b>	The average color of the bottom of the product with all gas pockets ignored for the calculation.
<b>Black Spots</b>	The surface area of the dark/black regions on the bottom of the product.
<b>Flour On Heel</b>	The surface area of the white (flour) regions on the bottom of the product.
<b>White Edges</b>	The surface area of the under-baked edges on the outer ring of the bottom of the product.

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